

Notice Inviting Quotation (E-Procurement mode)
कोटेशन को आमंत्रित करने की सूचना (ई-प्रोक्योरमेंट मोड)

INDIAN INSTITUTE OF TECHNOLOGY DELHI
भारतीय प्रौद्योगिकी संस्थान दिल्ली
HAUZ KHAS, NEW DELHI-110016
हौज खास, नई दिल्ली -110016

Dated/ दिनांक : 26/07/2021

Open Tender Notice No. / खुला प्रस्ताव निविदा सूचना नंबर: IITD/DMSE(SP-3557)/2021

Indian Institute of Technology Delhi is in the process of purchasing following item(s) as per details as given as under.

इंडियन इंस्टीट्यूट ऑफ टेक्नोलॉजी दिल्ली निम्नलिखित मदों की खरीद की प्रक्रिया में है।

Details of the item आइटम का विवरण	Multimode AFM with integrated IR spectroscopy
Earnest Money Deposit to be submitted बयाना जमा करने के लिए जमा राशि	NIL. However, bidders are required to submit 'Bid Security Undertaking' in lieu of EMD (Annexure-IX)
Warranty वारंटी अवधि	3 Years/3 साल
Performance security निष्पादन सुरक्षा	3% of FOB value
Delivery Schedule	12-16 Weeks after receipt of P.O.

Tender Documents may be downloaded from Central Public Procurement Portal <http://eprocure.gov.in/eprocure/app> . Aspiring Bidders who have not enrolled / registered in e-procurement should enroll / register before participating through the website <http://eprocure.gov.in/eprocure/app> . The portal enrolment is free of cost. Bidders are advised to go through instructions provided at 'Instructions for online Bid Submission'.

निविदा दस्तावेज केन्द्रीय सार्वजनिक खरीद पोर्टल <http://eprocure.gov.in/eprocure/app> से डाउनलोड हो सकते हैं ई-प्रोक्योरमेंट में पंजीकृत नहीं होने वाले इच्छुक बोलीदाताओं को वेबसाइट <http://eprocure.gov.in/eprocure/app> के माध्यम से भाग लेने से पहले पंजीकरण करना चाहिए। पोर्टल नामांकन मुफ्त है बोलीदाताओं को सलाह दी जाती है कि 'ऑनलाइन बोली के लिए निर्देश' पर दिए गए निर्देशों के माध्यम से जाने की सलाह दी जाए। Tenderers can access tender documents on the website (For searching in the NIC site, kindly go to Tender Search option and type 'IIT'. Thereafter, Click on "GO" button to view all IIT Delhi tenders). Select the appropriate tender and fill them with all relevant information and submit the completed tender document online on the website <http://eprocure.gov.in/eprocure/app> as per the schedule given in the next page. निविदाकर्ता वेबसाइट पर निविदा दस्तावेज का उपयोग कर सकते हैं (एनआईसी साइट में खोज के लिए, कृपया निविदा खोज विकल्प और 'आईआईटी' टाइप करें। उसके बाद, सभी आईआईटी दिल्ली निविदाओं को देखने के लिए "गो" बटन पर क्लिक करें) उपयुक्त निविदा का चयन करें और उन्हें सभी प्रासंगिक सूचनाओं से भरें और वेबसाइट पर <http://eprocure.gov.in/eprocure/app> पर पूरा निविदा दस्तावेज ऑनलाइन जमा करें। अगले पृष्ठ में दिए गए कार्यक्रम के अनुसार

No manual bids will be accepted. All quotation (both Technical and Financial should be submitted in the E-procurement portal).

कोई मैनुअल बोली स्वीकार नहीं की जाएगी। सभी कोटेशन (तकनीकी और वित्तीय दोनों को ई-प्रोक्योरमेंट पोर्टल में जमा करना चाहिए)

SCHEDULE

Name of Organization	Indian Institute of Technology Delhi
Tender Type (Open/Limited/EOI/Auction/Single/Global)	Open
Tender Category (Services/Goods/works)	Goods
Type/Form of Contract (Work/Supply/ Auction/ Service/ Buy/ Empanelment/ Sell)	Supply
Product Category (Civil Works/Electrical Works/Fleet Management/ Computer Systems)	Equipment
Source of Fund (Institute/Project)	Budget Code..... / Project Code <u>PLN12/02MS</u>
Is Multi Currency Allowed	YES
Date of Issue/Publishing	26/07/2021 (16:00 Hrs)
Document Download/Sale Start Date	26/07/2021 (16:00 Hrs)
Document Download/Sale End Date	23/08/2021 (15:00 Hrs)
Date for Pre-Bid Conference	---
Venue of Pre-Bid Conference	---
Last Date and Time for Uploading of Bids	23/08/2021 (15:00 Hrs)
Date and Time of Opening of Technical Bids	24/08/2021 (15:00 Hrs)
Tender Fee	Rs. ___NIL___/- (For Tender Fee) (To be paid through RTGS/NEFT. IIT Delhi Bank details are as under: Name of the Bank A/C : IITD Revenue Account SBI A/C No. : 10773572622 Name of the Bank : State Bank of India, IIT Delhi, Hauz Khas, New Delhi-110016 IFSC Code : SBIN0001077 MICR Code : 110002156 Swift No. : SBININBB547 (This is mandatory that UTR Number is provided in the on-line quotation/bid. (Kindly refer to the UTR Column of the Declaration Sheet at Annexure-II)
No. of Covers (1/2/3/4)	02
Bid Validity days (180/120/90/60/30)	120 days (From last date of opening of tender)
Address for Communication	Prof. Bijay P. Tripathi Department of Materials Science & Engineering Indian Institute of Technology Delhi New Delhi - 110016
Contact No.	Phone: +91-1126597364
Email Address	Email: bptripathi@mse.iitd.ac.in

**Chairman Purchase Committee
(Buyer Member)**

Instructions for Online Bid Submission/ ऑनलाइन बोली (बिड) के लिए निर्देश:

As per the directives of Department of Expenditure, this tender document has been published on the Central Public Procurement Portal ([URL:http://eprocure.gov.in/eprocure/app](http://eprocure.gov.in/eprocure/app)). The bidders are required to submit soft copies of their bids electronically on the CPP Portal, using valid Digital Signature Certificates. The instructions given below are meant to assist the bidders in registering on the CPP Portal, prepare their bids in accordance with the requirements and submitting their bids online on the CPP Portal.

व्यय विभाग के निर्देशों के अनुसार, यह निविदा दस्तावेज केंद्रीय सार्वजनिक प्रापण पोर्टल (यूआरएल: <http://eprocure.gov.in/eprocure/app>) पर प्रकाशित किया गया है। बोलीदाताओं को मान्य डिजिटल हस्ताक्षर प्रमाण पत्र का उपयोग करते हुए सीपीपी पोर्टल पर इलेक्ट्रॉनिक रूप से अपनी बोलियों की सॉफ्ट प्रतियां जमा करना आवश्यक है। सीपीपी पोर्टल पर पंजीकरण करने के लिए निविदाकर्ताओं की सहायता करने के लिए नीचे दिए गए निर्देशों का मतलब है, सीपीपी पोर्टल पर आवश्यकताओं के अनुसार अपनी बोलियां तैयार करें और अपनी बोलियां ऑनलाइन जमा करें।

More information useful for submitting online bids on the CPP Portal may be obtained at:

अधिक जानकारी सीपीपी पोर्टल पर ऑनलाइन बोलियां जमा करने के लिए उपयोगी हो सकती है:

<http://eprocure.gov.in/eprocure/app>

REGISTRATION

- 1) Bidders are required to enroll on the e-Procurement module of the Central Public Procurement Portal ([URL:http://eprocure.gov.in/eprocure/app](http://eprocure.gov.in/eprocure/app)) by clicking on the link "Click here to Enroll". Enrolment on the CPP Portal is free of charge.

बोलीदाताओं को "नामांकन के लिए यहां क्लिक करें" लिंक पर क्लिक करके सेंट्रल पब्लिक प्रोक्योरमेंट पोर्टल (यूआरएल: <http://eprocure.gov.in/eprocure/app>) के ई-प्रोक्योरमेंट मॉड्यूल पर भर्ती करना आवश्यक है। सीपीपी पोर्टल पर नामांकन नि: शुल्क है।

- 2) As part of the enrolment process, the bidders will be required to choose a unique username and assign a password for their accounts.

नामांकन प्रक्रिया के भाग के रूप में, बोलीदाताओं को अपने खाते के लिए एक अद्वितीय उपयोगकर्ता नाम चुनना होगा और एक पासवर्ड प्रदान करना होगा।

- 3) Bidders are advised to register their valid email address and mobile numbers as part of the registration process. These would be used for any communication from the CPP Portal.

बोलीदाताओं को सलाह दी जाती है कि पंजीकरण प्रक्रिया के भाग के रूप में अपना वैध ईमेल पता और मोबाइल नंबर पंजीकृत करें। इन का उपयोग सीपीपी पोर्टल से किसी भी संचार के लिए किया जाएगा।

- 4) Upon enrolment, the bidders will be required to register their valid Digital Signature Certificate (Class II or Class III Certificates with signing key usage) issued by any Certifying Authority recognized by CCA India (e.g. Sify / TCS / nCode / eMudhra etc.), with their profile.

नामांकन पर, बोलीदाताओं को सीसीए इंडिया द्वारा मान्यता प्राप्त किसी प्रमाणन प्राधिकरण द्वारा जारी किए गए अपने मान्य डिजिटल हस्ताक्षर प्रमाण पत्र (कक्षा द्वितीय या कक्षा III प्रमाण पत्र के साथ महत्वपूर्ण उपयोग पर हस्ताक्षर करने) की आवश्यकता होगी (जैसे सिफ़ी / टीसीएस / एनकोड / ई-मुद्रा आदि), उनके प्रोफाइल के साथ।

- 5) Only one valid DSC should be registered by a bidder. Please note that the bidders are responsible to ensure that they do not lend their DSCs to others which may lead to misuse.

केवल एक मान्य डीएससी एक बोलीदाता द्वारा पंजीकृत होना चाहिए। कृपया ध्यान दें कि निविदाकर्ता यह सुनिश्चित करने के लिए जिम्मेदार हैं कि वे अपने डीएससी को दूसरों को उधार नहीं देते हैं जिससे दुरुपयोग हो सकता है।

- 6) Bidder then logs in to the site through the secured log-in by entering their user ID / password and the password of the DSC / eToken.

बोलीदाता फिर अपने यूजर आईडी / पासवर्ड और डीएससी / ईटीकेन के पासवर्ड को दर्ज करके सुरक्षित लॉग-इन के माध्यम से साइट पर लॉग ऑन करता है।

SEARCHING FOR TENDER DOCUMENTS/ निविदा दस्तावेजों के लिए खोजना

- 1) There are various search options built in the CPP Portal, to facilitate bidders to search active tenders by several parameters. These parameters could include Tender ID, organization name, location, date, value, etc. There is also an option of advanced search for tenders, wherein the bidders may combine a number of search parameters such as organization name, form of contract, location, date, other keywords etc. to search for a tender published on the CPP Portal.

सीपीपी पोर्टल में निर्मित विभिन्न खोज विकल्प हैं, ताकि बोलीदाताओं को कई मापदंडों से सक्रिय निविदाएं खोज सकें। इन मापदंडों में निविदा आईडी, संगठन का नाम, स्थान, तिथि, मूल्य आदि शामिल हो सकते हैं। निविदाओं के लिए उन्नत खोज का एक विकल्प भी है, जिसमें बोलीदाता कई नामों को जोड़ सकते हैं जैसे संगठन का नाम, अनुबंध का स्थान, स्थान, सीपीपी पोर्टल पर प्रकाशित निविदा की खोज के लिए तारीख, अन्य कीवर्ड आदि।

- 2) Once the bidders have selected the tenders they are interested in, they may download the required documents / tender schedules. These tenders can be moved to the respective 'My Tenders' folder. This would enable the CPP Portal to intimate the bidders through SMS / e-mail in case there is any corrigendum issued to the tender document.

बोलीदाताओं ने एक बार निविदाएं चुनी हैं जिसमें वे रुचि रखते हैं, उसका वे आवश्यक दस्तावेज / निविदा कार्यक्रम डाउनलोड कर सकते हैं। ये निविदाएं 'मेरी निविदाओं' फ़ोल्डर में ले जाई जा सकती हैं। इससे सीपीपी पोर्टल को बोलीदाताओं को एसएमएस / ई-मेल के माध्यम से सूचित किया जा सकता है, यदि निविदा दस्तावेज में कोई शुद्धि जारी कि गई है।

- 3) The bidder should make a note of the unique Tender ID assigned to each tender, in case they want to obtain any clarification / help from the Helpdesk.

बोलीदाता को प्रत्येक निविदा को निर्दिष्ट अद्वितीय निविदा आईडी का नोट बनाना चाहिए, अगर वे हेल्पडेस्क से कोई स्पष्टीकरण / सहायता प्राप्त करना चाहते हैं।

PREPARATION OF BIDS / बोली (बिड) की तैयारी

- 1) Bidder should take into account any corrigendum published on the tender document before submitting their bids.

बोलीदाता को अपनी बोलियां जमा करने से पहले निविदा दस्तावेज पर प्रकाशित किसी भी शुद्धि को ध्यान में रखना चाहिए।

- 2) Please go through the tender advertisement and the tender document carefully to understand the documents required to be submitted as part of the bid. Please note the number of covers in which the bid documents have to be submitted, the number of documents - including the names and content of each of the document that need to be submitted. Any deviations from these may lead to rejection of the bid.

कृपया बोली के भाग के रूप में जमा किए जाने वाले दस्तावेजों को समझने के लिए निविदा विज्ञापन और निविदा दस्तावेज ध्यान से देखें। कृपया उन अंकों की संख्या पर ध्यान दें जिन में बोली दस्तावेज जमा करना है, दस्तावेजों की संख्या - जिसमें प्रत्येक दस्तावेज के नाम और सामग्री शामिल हैं, जिन्हें प्रस्तुत करने की आवश्यकता है। इनमें से कोई भी विचलन बोली को अस्वीकार कर सकता है।

- 3) Bidder, in advance, should get ready the bid documents to be submitted as indicated in the tender document / schedule and generally, they can be in PDF / XLS / RAR / DWF formats. Bid documents may be scanned with 100 dpi with black and white option.

बोलीदाता, अग्रिम में, निविदा दस्तावेज / अनुसूची में बताए अनुसार प्रस्तुत करने के लिए बोली दस्तावेज तैयार करना चाहिए और आम तौर पर, वे पीडीएफ / एक्सएलएस / आरएआर / डीडब्ल्यूएफ स्वरूपों में हो सकते हैं। बोली दस्तावेजों को 100 डीपीआई के साथ काले और सफेद विकल्प स्कैन किया जा सकता है।

- 4) To avoid the time and effort required in uploading the same set of standard documents which are required to be submitted as a part of every bid, a provision of uploading such standard documents (e.g. PAN card copy, annual reports, auditor certificates etc.) has been provided to the bidders. Bidders can use “My Space” area available to them to upload such documents. These documents may be directly submitted from the “My Space” area while submitting a bid, and need not be uploaded again and again. This will lead to a reduction in the time required for bid submission process.

मानक दस्तावेजों के एक ही सेट को अपलोड करने के लिए आवश्यक समय और प्रयास से बचने के लिए जो प्रत्येक बोली के भाग के रूप में जमा करने के लिए आवश्यक हैं, ऐसे मानक दस्तावेज अपलोड करने का प्रावधान (जैसे पैन कार्ड कॉपी, वार्षिक रिपोर्ट, लेखा परीक्षक प्रमाण पत्र आदि) बोलीदाताओं को प्रदान किया गया है। ऐसे दस्तावेजों को अपलोड करने के लिए बोलीकर्ता उनके लिए उपलब्ध "मेरा स्पेस" क्षेत्र का उपयोग कर सकते हैं। बोली जमा करते समय ये दस्तावेज सीधे "मेरा स्पेस" क्षेत्र से जमा किए जा सकते हैं, और उन्हें बार-बार अपलोड करने की ज़रूरत नहीं है इससे बोली जमा प्रक्रिया के लिए आवश्यक समय में कमी आएगी।

SUBMISSION OF BIDS/ बोली (बिड) का जमा करना

- 1) Bidder should log into the site well in advance for bid submission so that he/she upload the bid in time i.e. on or before the bid submission time. Bidder will be responsible for any delay due to other issues.

बोलीदाता को बोली प्रस्तुति के लिए अच्छी तरह से साइट पर लॉग इन करना चाहिए ताकि वह समय पर बोली अपलोड कर सके या फिर बोली प्रस्तुत करने के समय से पहले। अन्य मुद्दों के कारण किसी भी देरी के लिए बोलीदाता जिम्मेदार होगा।

- 2) The bidder has to digitally sign and upload the required bid documents one by one as indicated in the tender document.

बोलीदाता को निविदा दस्तावेज में दर्शाए अनुसार एक-एक करके आवश्यक बोली दस्तावेजों को डिजिटल हस्ताक्षर और अपलोड करना होगा।

- 3) Bidder has to select the payment option as “on-line” to pay the tender fee / EMD as applicable and enter details of the instrument. Whenever, EMD / Tender fees is sought, bidders need to pay the tender fee and EMD separately on-line through RTGS (Refer to Schedule, Page No.2).

बोलीदाता को निविदा शुल्क / ईएमडी को भुगतान के लिए "ऑन लाइन" के रूप में भुगतान विकल्प चुनना होगा और उपकरण का विवरण दर्ज करना होगा। जब भी, ईएमडी / निविदा शुल्क की मांग की जाती है, बोलीदाताओं को टेंडर शुल्क और ईएमडी अलग-अलग आरटीजीएस के माध्यम से ऑन लाइन पर भुगतान करने की आवश्यकता होती है (अनुसूची, पेज नं .2 देखें)।

- 4) A standard BoQ format has been provided with the tender document to be filled by all the bidders. Bidders are requested to note that they should necessarily submit their financial bids in the format provided and no other format is acceptable. Bidders are required to download the BoQ file, open it and complete the white colored (unprotected) cells with their respective financial quotes and other details (such as name of the bidder). No other cells should be changed. Once the details have been completed, the bidder should save it and submit it online, without changing the filename. If the BoQ file is found to be modified by the bidder, the bid will be rejected.

एक मानक BoQ प्रारूप को सभी बोलीदाताओं द्वारा भरने के लिए निविदा दस्तावेज प्रदान किया गया है। बोलीदाताओं को इस बात का ध्यान रखना चाहिए कि उन्हें आवश्यक प्रारूप में अपनी वित्तीय बोली जमा करनी चाहिए और कोई अन्य प्रारूप स्वीकार्य नहीं है। बोलीकर्ताओं को BoQ फाइल को डाउनलोड करने, इसे खोलने और अपने संबंधित वित्तीय उद्धरण और अन्य विवरण (जैसे बोलीदाता का नाम) के साथ सफेद रंगीन (असुरक्षित) कोशिकाओं को पूरा करना आवश्यक है। कोई भी अन्य कक्ष नहीं बदला जाना चाहिए। एक बार विवरण पूरा हो जाने पर, बोलीदाता को इसे सहेजना होगा और इसे ऑनलाइन जमा करना होगा, बिना फ़ाइल नाम बदलना। यदि BOQ फ़ाइल को बोलीदाता द्वारा संशोधित किया गया है, तो बोली को खारिज कर दिया जाएगा।

- 5) The server time (which is displayed on the bidders’ dashboard) will be considered as the standard time for referencing the deadlines for submission of the bids by the bidders, opening of bids etc. The bidders should follow this time during bid submission.

सर्वर का समय (जो बोलीदाताओं के डैशबोर्ड पर प्रदर्शित होता है) बोलीदाताओं द्वारा बोलियों को खोलने के लिए समय सीमा को संदर्भित करने के लिए मानक समय के रूप में माना जाएगा। बोलीदाताओं को खोलना आदि। बोलीदाताओं को बोली प्रस्तुत करने के दौरान इस समय का पालन करना चाहिए।

- 6) All the documents being submitted by the bidders would be encrypted using PKI encryption techniques to ensure the secrecy of the data. The data entered cannot be viewed by unauthorized persons until the time of bid opening. The confidentiality of the bids is maintained using the secured Socket Layer 128 bit encryption technology. Data storage encryption of sensitive fields is done.

बोलीदाताओं द्वारा प्रस्तुत सभी दस्तावेज पीकेआई एन्क्रिप्शन तकनीकों का उपयोग करके एन्क्रिप्ट किया जाएगा जिससे डेटा की गोपनीयता सुनिश्चित हो सके। दर्ज किए गए डेटा को अनधिकृत व्यक्तियों द्वारा बोली खोलने के समय तक नहीं देखा जा सकता है। बोलियों की गोपनीयता को सुरक्षित सॉकेट लेयर 128 बिट एन्क्रिप्शन तकनीक का उपयोग कर रखा जाता है। संवेदनशील क्षेत्रों का डेटा संग्रहण एन्क्रिप्शन किया जाता है।

- 7) The uploaded tender documents become readable only after the tender opening by the authorized bid openers.

अपलोड किए गए निविदा दस्तावेज केवल अधिकृत बोलीदाता द्वारा निविदा खोलने के बाद ही पठनीय हो सकते हैं।

- 8) Upon the successful and timely submission of bids, the portal will give a successful bid submission message & a bid summary will be displayed with the bid no. and the date & time of submission of the bid with all other relevant details.

बोलियों के सफल और समय पर जमा होने पर, पोर्टल एक सफल बोली प्रस्तुत करने का संदेश देगा और एक बोली सारांश बोली संख्या के साथ प्रदर्शित किया जाएगा। और अन्य सभी प्रासंगिक विवरणों के साथ बोली प्रस्तुत करने की तारीख और समय।

- 9) Kindly add scanned PDF of all relevant documents in a single PDF file of compliance sheet.

कृपया अनुपालन पत्रक की एक पीडीएफ फाइल में सभी प्रासंगिक दस्तावेजों के स्कैन किए गए पीडीएफ को जोड़ दें।

ASSISTANCE TO BIDDERS / बोलीदाताओं को सहायता

- 1) Any queries relating to the tender document and the terms and conditions contained therein should be addressed to the Tender Inviting Authority for a tender or the relevant contact person indicated in the tender.

निविदा दस्तावेज से संबंधित कोई भी प्रश्न और इसमें निहित नियमों और शर्तों को निविदा आमंत्रण प्राधिकरण को निविदा के लिए या निविदा में वर्णित प्रासंगिक संपर्क व्यक्ति से संबोधित किया जाना चाहिए।

- 2) Any queries relating to the process of online bid submission or queries relating to CPP Portal in general may be directed to the 24x7 CPP Portal Helpdesk. The contact number for the helpdesk is 1800 233 7315.

ऑनलाइन बोली प्रस्तुत करने या सामान्य में सीपीपी पोर्टल से संबंधित प्रश्नों की प्रक्रिया से संबंधित कोई भी प्रश्न 24x7 सीपीपी पोर्टल हेल्पडेस्क पर निर्देशित किया जा सकता है। हेल्पडेस्क के लिए संपर्क संख्या 1800 233 7315 है

General Instructions to the Bidders / बोलीदाताओं के लिए सामान्य निर्देश

- 1) The tenders will be received online through portal <http://eprocure.gov.in/eprocure/app> . In the Technical Bids, the bidders are required to upload all the documents in .pdf format.

निविदाएं पोर्टल <http://eprocure.gov.in/eprocure/app> के माध्यम से ऑनलाइन प्राप्त होंगी तकनीकी बोलियों में, बोलीदाताओं को सभी दस्तावेजों को पीडीएफ प्रारूप में अपलोड करना होगा।

- 2) Possession of a Valid Class II/III Digital Signature Certificate (DSC) in the form of smart card/e-token in the company's name is a prerequisite for registration and participating in the bid submission activities through <https://eprocure.gov.in/eprocure/app>. Digital Signature Certificates can be obtained from the

authorized certifying agencies, details of which are available in the web site <https://eprocure.gov.in/eprocure/app> under the link "Information about DSC".

कंपनी के नाम में स्मार्ट कार्ड / ई-टोकन के रूप में मान्य क्लास II / III डिजिटल हस्ताक्षर प्रमाण पत्र (डीएससी) के पंजीकरण के लिए एक शर्त है और <https://eprocure.gov.in/eprocure/> के माध्यम से बोली प्रस्तुत करने की गतिविधियों में भाग ले सकते हैं। डिजिटल हस्ताक्षर प्रमाण पत्र अधिकृत प्रमाणित एजेंसियों से प्राप्त की जा सकती है, जिनमें से जानकारी "डीएससी के बारे में सूचना" लिंक के तहत वेब साइट <https://eprocure.gov.in/eprocure/app> पर उपलब्ध है।

- 3) Tenderer are advised to follow the instructions provided in the 'Instructions to the Tenderer for the e-submission of the bids online through the Central Public Procurement Portal for e Procurement at <https://eprocure.gov.in/eprocure/app>.

निविदाकर्ता को सलाह दी जाती है कि वे निविदाकार को निर्देश दिए गए हों ताकि ई-प्रोक्योरमेंट के लिए सेंट्रल पब्लिक प्रोक्ॉर्ममेंट पोर्टल के जरिए <https://eprocure.gov.in/eprocure/app> पर ऑनलाइन निविदाएं जमा कर सकें।

Department of Materials Science & Engineering
Indian Institute of Technology
Hauz Khas, New Delhi-110 016

NOTICE INVITING QUOTATIONS

Subject : <Purchase of Multimode AFM with integrated IR spectroscopy

Invitation for Tender Offers

Indian Institute of Technology Delhi invites online Bids (Technical bid and Commercial bid) from eligible and experienced OEM (Original Equipment Manufacturer) OR OEM Authorized Dealer for **supply, installation & training of a Multimode AFM with integrated IR spectroscopy** with (warranty period as stated at page #1 of this tender) on site comprehensive warranty from the date of receipt of the material as per terms & conditions specified in the tender document, which is available on CPP Portal <http://eprocure.gov.in/eprocure/app>

TECHNICAL SPECIFICATION:

General Specifications:

Integrated Multimode Atomic Force Microscope with Nanoscale Infrared Spectroscopy Microscope with tunable IR laser as the source for covering broad IR Range. Multimode AFM with varieties of modules offers mechanical, electronic, and thermal characterization at the surface and at the nanoscale. Along with tunable IR laser sources, it will allow mapping both topography and IR absorption (chemical signature(s)) at the nanometer scale. The system should provide high spatial resolution, excellent sensitivity, and correlation to bulk FTIR spectra. The system should be based on a Non-Destructive Technique in IR Imaging. The system must be capable of measuring the AFM-IR data of both Organic and Inorganic materials, which includes 1D/2D Materials, CNTs, Polymers, Polymers Blends, Block Copolymer, Oxide, and non-oxide Thin Films, Glass, Semiconductors, Fibers, Hydrocarbons, Cells, Biomaterials, Nanophotonics, Nanoplasmonics, Organic/Inorganic Composites, OLED Materials, Zeolite, Soft samples, Monolayer, etc. Further, the system should be capable of characterizing various mechanical (such as tribological, viscoelastic, etc. properties;), electronic (electrostatic, magnetic, Kelvin probe, conductive, etc. properties), and thermal properties (temperature-dependent mechanical and electrical property, thermal conductivity, etc.) Peer-reviewed scientific publications should be provided for proof of all the capabilities claimed in the tender. Detailed specifications are described below:

1.	AFM Specifications
1.1.	Scanner head:
1.1.1.	AFM Head/Scanner Material should be made from material for best thermal stability. Invar would be preferred.
1.1.2.	AFM Deflection Laser wavelength should be higher or equal to 600 nm or equivalent.

1.1.3.	System z-noise floor <100 pm rms
1.1.4.	Detector Bandwidth: up to 6 MHz
1.1.5.	Operational modes: Ambient and liquid cell
1.1.6.	Should support all standard modes of operation with the possibility for upgradation with specific modes or the features given in the optional list.
1.1.7.	Provide Tapping mode and contact mode based on photothermal technique/photo-induced force microscopy for IR spectra and chemical imaging covering the full requested Laser range. Vendors must also provide AFM IR mode operating at resonance for characterizing monolayers and thin films.
1.1.8.	AFM head incorporates a parabolic mirror controlled by 3D piezo motor/scanner, allowing the laser to excite the sample and tip from the top side. The range of parabolic mirror is 1 mm × 1 mm × 0.8 mm (stepping mode), and 15 μm × 15 μm × 15 μm (scanning mode) with 10 nm resolution, the NA of the parabolic mirror is ~0.5. Any other equivalent technology providing equivalent or better results is also acceptable.
1.1.9.	Either inverted or top view illumination is preferred.
1.1.10.	Sample size: 25 mm x 25 mm x 10 mm or more.
1.2.	Scanner
1.2.1.	XY& Z range - 80 micron × 80 micron × 10 micron or better.
1.2.2.	Dual Z feedback – The AFM feedback mechanism must drive both the sample Z with ≥ 10 μm range and fast tip Z piezo with ≤ 1 μm with 20kHz bandwidth. Piezo elements to produce the best AFM feedback while maintaining the tight focus of the excitation laser on the tip apex region. Any other equivalent technology providing similar or better results is also acceptable.
1.2.3.	Scanner operation Closed loop with capacitive sensors in XY & Z
1.2.4.	XY Scanning Sensor Noise: <200 pm or lower
1.2.5.	Z scanner sensor noise: <100 pm or better for the full range
1.2.6.	The system should have a flexure design
1.3.	Positioning System
1.3.1.	Motorized Coarse positioning range of tip in Z > 10 mm
1.3.2.	XY positioning type of sample at a minimum of 25 mm x 25 mm motorized with absolute position sensor
1.3.3.	The system shall include an integrated optical microscope coupled to a 5MP digital camera and computer display. The optical imaging shall be in top view (i.e., looking down on the cantilever), with a minimum spatial resolution of 2 μm. Any other equivalent technology providing similar or better results is also acceptable.
1.3.4.	XY sample positioning repeatability < 1 μm

1.3.5.	Sensor resolution for position sensor < 100 nm rms
1.4.	AFM modes
1.4.1.	The system should be capable of providing high resolution imaging at typical imaging speeds (~2min/scan with 256x256 pixels) in air and the liquid environment by imaging at the off-resonance frequency by driving the z scanner in sinusoid fashion. The oscillation should be user controlled and vary up to 2kHz or greater.
1.4.2.	Contact mode
1.4.3.	Tapping mode (air/liquid).
1.4.4.	Thermal tuning
1.4.5.	Liquid Imaging for AFM only
1.4.6.	Lateral Force Microscopy
1.4.7.	Force spectroscopy
1.4.8.	Phase Imaging
1.4.9.	Magnetic Force Microscopy (MFM)
1.4.10.	Kelvin Probe Force Microscopy (KPFM) for surface potential
1.4.11.	Piezoresponse force microscopy (PFM) with +/- 10V or higher
1.4.12.	Electrostatic force microscopy (EFM).
1.4.13.	Nanoscale mechanical mode or equivalent mode providing:
1.4.13.1.	AFM-based Dynamic Mechanical Analysis with sample modulation from 0.1Hz to 300Hz or equivalent or better
1.4.13.2.	Provide results of storage modulus (E'), loss modulus (E''), and tan delta for a complete rheological analysis at sub-100 nm spatial resolution with excellent correlation to bulk DMA and nanoindentation methods.
1.4.13.3.	Provide spectroscopy capabilities for single points, point-arrays, or mapping at a rheological frequency range of 0.1Hz to 300Hz or broader with variable temperature from room temperature (RT) to 250-degrees Celsius or equivalent or better
1.4.13.4.	Able to characterize rheological behavior of viscoelastic materials to generate master curves through a comprehensive process to generate time-temperature superposition data and calculate activation energy using the Arrhenius model.
1.4.13.5.	Should have a high stability sample heater, RT to 250-degrees Celsius in the air or other inert gases to measure samples at various temperatures required for calculating time-temperature superposition material master curves.
1.4.13.6.	Should have a temperature controller and a chiller for high efficiency heating and fast temperature ramping controlled through software

1.4.13.7.	Provide reference sample kits consisting of the following samples/substrates: one (1) Fluorinated Ethylene Propylene, one (1) Polycarbonate-ABS, and ten (10) 10mm Sapphire windows
1.4.13.8.	Includes 10 Calibrated Probes each of different Models applicable for quoted system
1.4.13.9.	Includes a heater cantilever holder and standard cantilever holder
1.5.	Conductive AFM:
1.5.1.	Measure conductive properties in both contact and tapping mode at typical imaging speed (<2 min/scan of 256x256 pixels).
1.5.2.	Achieves >10kHz bandwidth for peak current detection and provides sub-100fA noise level
1.5.3.	10 probes with the complete package.
1.6.	Sample Heating Cooling Stage:
1.6.1.	Room Temperature to 250 Deg C or more
1.6.2.	-20 Deg C to 80 Deg C or better.
1.7.	AFM probes:
1.7.1.	200 number of tips for use in AFM-IR.
1.7.2.	Two Contact/tapping (air) cantilever holders,
1.7.3.	20 numbers of probes and required accessories for each specific AFM mode should be provided.
1.8.	Optical access top view for position observation
1.8.1.	Top optics (for position observation) 10X, 0.2 NA Lens or equivalent or better
1.8.2.	Tip-Sample Approach: Automated engagement via 3 stepper motors or equivalent
1.8.3.	Illumination: Software controlled LED
1.8.4.	CCD camera: > 5MP, with pixel image resolution of 500 nm or better and optical spatial resolution < 1.5 μm) or better or equivalent.
2.	Tunable Infrared Laser Source and Imaging
2.1.	QCL IR Source
2.1.1.	Tuning range - ~770 cm ⁻¹ to 1860 cm ⁻¹ or more
2.1.2.	Spectral linewidth <2 cm ⁻¹ or better
2.1.3.	Spectral Accuracy <2 cm ⁻¹ or or equivalent or better
2.1.4.	Repeatability: <0.5 cm ⁻¹ or or equivalent or better
2.1.5.	Average Power: 1 - 15 mW over the entire tuning range
2.1.6.	Power Stability: <5% pulse-to-pulse (typical)
2.1.7.	Pulse Repetition Frequency: up to 3 MHz;
2.1.8.	Pointing Stability: <2 mrad in full tuning range and 40 msec tuning speed in full range to support fast spectrum acquisition with 0.1 s per spectrum and hyperspectral IR imaging with a spectrum over full range in every pixel

2.1.9.	Cooling: Water cooling for silent operation. Appropriate chillers should be included in the quotation.
2.1.10.	Required multiplexer/tuners should be included to cover the complete range of the source as mentioned above.
2.1.11.	Beam steering: 3D piezo motor/scanner/Motorized tip/tilt
2.1.12.	With the Pulsed QCL laser source, it should be possible to operate in hyperspectral imaging and spectroscopy in the complete tunable range
2.1.13.	Speeds of 0.2 seconds per pixel should be possible per spectrum
2.2.	OPO Laser
2.2.1.	OPO Single Housing Picosecond Laser
2.2.2.	85 MHz \pm 5 MHz PRR;
2.2.3.	70 \pm 10 ps pulse duration;
2.2.4.	Tuning ranges; 2250 cm ⁻¹ –3600 cm ⁻¹ or broader
2.2.5.	Spectral resolution: <4 cm ⁻¹ or equivalent or better
2.2.6.	Beam diameter 2-3 mm
2.2.7.	Acoustic-optic modulator to allow heterodyne AFM measurements with non-contact AFM cantilevers. Any other equivalent technology is acceptable.
2.2.8.	Material: single crystal optical germanium or equivalent
2.2.9.	Water cooling: 250 ml/min approximately 23 °C or equivalent or better. appropriate chillers to be provided
2.2.10.	Size (less connector): 38.1 h x 76.2 d x 33.0 w cm;
2.2.11.	Modulator driver
2.2.12.	Motorized laser multiplexer to accommodate OPO and QCL lasers with additional available ports.
2.2.13.	Automatic switching between OPO and QCL sources should be possible (if applicable).
2.3.	Nanoscale IR Imaging
	The system must be able to generate both fixed wavenumber images and spectrum with the same laser/s. The spectrum on PES (polyethersulfone) must be generated and shown good agreement with a published FTIR spectrum.
3.	Controller, Software, PC, Active Vibration
3.1.1.	High-Speed Electronics & Controller Module
3.1.1.1.	FPGA-based control electronics have a section dedicated to high-speed scanning probe microscopy.
3.1.1.2.	Sampling Rate: >500 MHz for channels A & B; Channel A dedicated for photodiode detection for high-speed AFM
3.1.1.3.	Lock-in Amplifiers (LIA): 3 or more independent 2-phase lock-in amplifiers (LIA0 to LIA3). LIA Operation Frequency: Up to 10 MHz. LIA Synchronization: fully synchronized from one clock source.
3.1.1.4.	High-Speed Sine Wave Generator: Two channels with 160 kHz sampling rates; one reserved for scan generator for high-speed AFM

3.1.1.5.	Maximum Feedback Throughput: 1 Mps with Dual-Z feedback
3.1.1.6.	Integrated Synchronized Laser Driver.
3.1.1.7.	Standard DAC Channels: 10 or more channels: 20-bit or higher, >150 kHz data rate
3.1.1.8.	Standard ADC Channels: 8 or more channels: 20-bit or higher, >150 kHz data rate
3.1.1.9.	TTL Signal Generator: Two flexible TTL signal generators (with 160 kHz sampling rate) with adjustable duty cycle and DC offset for direct current modulation of laser diodes or for input to Bragg cells. Or equivalent.
3.1.1.10.	Flexible Lock-in Referencing: The LIAs can be phase locked to any other LIA or at any calculated frequencies from the other LIAs
3.1.2.	Image Acquisition Software:
3.1.2.1.	Should have the capability to locate and zoom in/out of pre-acquired images on the same sample.
3.1.2.2.	The system must provide simultaneous measurement of IR absorption, sample topography, and contact resonance based mechanics from the amplitude and frequency of the cantilever oscillation. Publications should be provided for proof of capability.
3.1.2.3.	AFM IR absorption detection mechanism must be fully disclosed and must not be in conflict with any registered patents. References to be provided.
3.1.2.4.	Straightforward interpretation of detection of infrared absorption, e.g., without need to interpret or model complex scattering near-field optical signal. Provide proof through peer reviewed publications that such spectral interpretations are indeed possible for solid samples.
3.1.2.5.	The technique should directly correlate to FTIR libraries for polymeric materials with proven examples.
3.1.2.6.	Provide both high resolution spectroscopy and fixed wavelength chemical imaging with the same mid-IR laser source.
3.1.2.7.	Automated background compensation for IR spectroscopy
3.1.2.8.	Demonstrate <10 nm chemical imaging spatial resolution. Provide proof with measurement data
3.1.2.9.	Tapping mode based photothermal technique must be insensitive to non-local background forces providing material selectivity via resonance tuning technique
3.1.2.10.	HOTspot tracking and optimization of IR laser onto the probe tip to minimize measurement set-up times
3.1.2.11.	QCL based laser provides both spectroscopy and chemical imaging for Tapping AFM-IR and Resonance enhanced (Contact) AFM-IR across the fully accessible spectral range.
3.1.2.12.	The system must allow the user to perform IR imaging at any fixed wavenumber within the tuning range of the IR source and allow for image ratio and subtraction analysis

3.1.2.13.	Provide the capability for hyperspectral imaging with the photothermal or equivalent AFM-IR technique providing spectra at each pixel with <1sec and a spectral array map of up to 128 x 128 pixels.
3.1.3.	Environmental
3.1.3.1.	Suitable vibration isolation and environmental control must be included to ensure the performance and operation of all mentioned AFM and AFM-IR modes.
3.1.3.2.	Suitable Active Vibration Isolation system with active bandwidth 0.6 to 200 Hz
3.1.3.3.	Acoustic Enclosure with the capability to keep the temperature controlled to +/- 0.2C. Front door with gas lift and opens upwards.
3.1.3.4.	Dry Air generator/filtration set up to provide quiet, clean, and water-absorption-free operation. Any other equivalent technology will be acceptable.
3.1.3.5.	Provide an option for AFM-IR in environmental control with humidity control. The humidity control should be from 10% to 80% or better, non-condensing.
3.1.4.	Computer:
3.1.4.1.	Suitable table and rack for computer/CPU.
3.1.4.2.	Minimum configuration includes 3.4GHz Quad Core (Intel i7 or equivalent processor), 16 GB RAM, 256GB SSD, and 2000GB HD combination, 8X USB ports, Windows 10-64 bit Professional or better configuration.
3.1.4.3.	Two flat-panel computer monitors (minimum size 30") for simultaneous display of multiple control menus, analysis, and images.
3.1.5.	Suitable UPS should be provided with at least 1 hr backup.
4.	Other terms and conditions:
4.1.	Support and Service
4.1.1.	The Supplier shall provide a comprehensive warranty for a minimum of three (3) years from the date of installation. Warranty must include unlimited telephone/e-mail support during the warranty period for questions regarding operation.
4.1.2.	If a less than 3-year warranty is offered for any particular component, then suitable justification should be provided with an optional quote for an additional warranty period. The committee will have the right to accept it or not.
4.1.3.	This warranty must cover non-consumable parts replacement and travel/labor on-site should this become necessary within the warranty period.
4.1.4.	For the warranty period, only factory-trained and certified engineers are acceptable to attend the service.
4.1.5.	The response time with an engineer on site must be less than 48 hours from the failure notification. The company must provide evidence that it can fulfill this requirement.

4.1.6.	If the parts are required to be imported for repairs, the same should be made available within 4 weeks from the date of reporting the issue. Any extension in this time will need to be compensated by the manufacturer by extending the comprehensive warranty by the excess period taken (i.e., the period beyond 4 weeks) in completing the repairs.
4.1.7.	The supplier must provide sophisticated web-based instrument diagnostics to provide the customer with rapid support for applications assistance and instrument troubleshooting.
4.1.8.	The supplier should arrange 6 training sessions (spread over the first two years).
4.1.9.	Full-time free upgrade of the software associated with the equipment.
4.1.10.	Any data analysis software required for the system should be made available for at least 10 computers.
4.1.11.	Details of the installation and user response should be provided from at least 3 reputed international/national labs and universities.
4.1.12.	All prices quoted for CIP New Delhi
4.2.	Acceptance Criteria
4.2.1.	Checking together with the customer that the instrument is delivered in full and in agreement with the PO.
4.2.2.	XYZ Calibration: Performed the Z calibration using the XYZ calibration sample and confirm the calibration with the Z center voltage centered is within the specification.
4.2.3.	Z noise: Engage on freshly cleaved HOPG in tapping with new 125um probe. Change Setpoint to 10V to retract piezo. Do cantilever tune and check f is just to the left of the peak. Adjust drive strength, so the amplitude is 9V. Now change Setpoint to 7.5 V. Scan at 0.003 x 0.001 um, 1 Hz, 512 x 64, ig=2.5 pg=5.0. Capture height image. Do 1 st order flatten, measure RMS of the entire image. It should be below 100 pm, with no periodic noises.
4.2.4.	All the lasers must be capable of AFM-IR by cantilever detection for both fixed wavenumber imaging and single and multipoint full range spectra. The spatial resolution of AFM IR should be at least 10 nm. The 10 nm spatial resolution must be demonstrated during the site acceptance test by imaging a PS-PMMA block copolymer with a half pitch of 21 nm or smaller; the PS block should be acquired at ~ 1492 cm ⁻¹ and ~ 2956 cm ⁻¹ and PMMA at ~ 1733 cm ⁻¹ and ~ 2853 cm ⁻¹ along with AFM topography and phase.

Sl. No.	List of optional items
1.	Two-year ACMC after the end of comprehensive warranty

A complete set of tender documents* may be Download by prospective bidder free of cost from the website <http://eprocure.gov.in/eprocure/app>. Bidder has to make payment of requisite fees (i.e. Tender fees (if any) and EMD) online through RTGS/NEFT only.

Terms & Conditions Details

Sl. No.	Specification
1.	Due date: The tender has to be submitted on-line before the due date. The offers received after the due date and time will not be considered. No manual bids will be considered.
2.	Preparation of Bids: The offer/bid should be submitted in two bid systems (i.e.) Technical bid and financial bid. The technical bid should consist of all technical details along with commercial terms and conditions. Financial bid should indicate item wise price for the items mentioned in the technical bid in the given format i.e BoQ_XXXX. The Technical bid and the financial bid should be submitted Online. Note: -Comparison of prices will be done ONLY on the bids submitted for the Main Equipment and anything asked as 'Optional' in the specs is not to be included for overall comparison.
3.	EMD (if applicable): The tenderer should submit an EMD amount through RTGS/NEFT. The Technical Bid without EMD would be considered as UNRESPONSIVE and will not be accepted. The EMD will be refunded without any interest to the unsuccessful bidders after the award of contract. Refer to Schedule (at page 1 of this document) for its actual place of submission.
4.	Refund of EMD: The EMD will be returned to unsuccessful Tenderer only after the Tenders are finalized. In case of successful Tenderer, it will be retained till the successful and complete installation of the equipment.
5.	Opening of the tender: The online bid will be opened by a committee duly constituted for this purpose. Online bids (complete in all respect) received along with EMD (if any) will be opened as mentioned at "Annexure: Schedule" in presence of bidders representative if available. Only one representative will be allowed to participate in the tender opening. Bid received without EMD (if present) will be rejected straight way. The technical bid will be opened online first and it will be examined by a technical committee (as per specification and requirement). The financial offer/bid will be opened only for the offer/bid which technically meets all requirements as per the specification, and will be opened in the presence of the vendor's representatives subsequently for further evaluation. The bidders if interested may participate on the tender opening Date and Time. The bidder should produce authorization letter from their company to participate in the tender opening.
6.	Acceptance/ Rejection of bids: The Committee reserves the right to reject any or all offers without assigning any reason.
7.	Pre-qualification criteria: (i) Bidders should be the manufacturer / authorized dealer. Letter of Authorization from original equipment manufacturer (OEM) on the same and specific to the tender should be enclosed. (ii) An undertaking from the OEM is required stating that they would facilitate the bidder on a regular basis with technology/product updates and extend support for the warranty as well. (Ref. Annexure-II) (iii) OEM should be internationally reputed Branded Company. (iv) Non-compliance of tender terms, non-submission of required documents, lack of clarity of the specifications, contradiction between bidder specification and supporting documents etc. may lead to rejection of the bid. (v) In the tender, either the Indian agent on behalf of the Principal/OEM or Principal/OEM itself can bid but both cannot bid simultaneously for the same item/product in the same tender. (vi) If an agent submits bid on behalf of the Principal/OEM, the same agent shall not submit a bid on behalf of another Principal/OEM in the same tender for the same item/product.
8.	Performance Security: The supplier shall require to submit the performance security in the form of irrevocable bank guarantee issued by any Indian Nationalized Bank for an amount which is stated at page #1 of the tender document within 21 days from the date of receipt of the purchase order/LC and should be kept valid for a period of 60 days beyond the date of completion of warranty period.

9.	<p>Force Majeure: The Supplier shall not be liable for forfeiture of its performance security, liquidated damages or termination for default, if and to the extent that, it's delay in performance or other failure to perform its obligations under the Contract is the result of an event of Force Majeure.</p> <ul style="list-style-type: none"> ● For purposes of this Clause, "Force Majeure" means an event beyond the control of the Supplier and not involving the Supplier's fault or negligence and not foreseeable. Such events may include, but are not limited to, acts of the Purchaser either in its sovereign or contractual capacity, wars or revolutions, fires, floods, epidemics, quarantine restrictions and freight embargoes. ● If a Force Majeure situation arises, the Supplier shall promptly notify the Purchaser in writing of such conditions and the cause thereof. Unless otherwise directed by the Purchaser in writing, the Supplier shall continue to perform its obligations under the Contract as far as is reasonably practical, and shall seek all reasonable alternative means for performance not prevented by the Force Majeure event.
10.	<p>Risk Purchase Clause: In event of failure of supply of the item/equipment within the stipulated delivery schedule, the purchaser has all the right to purchase the item/equipment from the other source on the total risk of the supplier under risk purchase clause.</p>
11.	<p>Packing Instructions: Each package will be marked on three sides with proper paint/indelible ink, the following:</p> <ol style="list-style-type: none"> i. Item Nomenclature ii. Order/Contract No. iii. Country of Origin of Goods iv. Supplier's Name and Address v. Consignee details vi. Packing list reference number
12.	<p>Delivery and Documents: Delivery of the goods should be made within a maximum of 12 to 16 weeks (<i>for goods ready for shipment</i>) & Maximum (<i>To be filled by Purchaser</i>) weeks (<i>For special/ to be fabricated goods</i>) from the date of the opening of LC. Within 24 hours of shipment, the supplier shall notify the purchaser and the insurance company by cable/telex/fax/e mail the full details of the shipment including contract number, railway receipt number/ AAP etc. and date, description of goods, quantity, name of the consignee, invoice etc. The supplier shall mail the following documents to the purchaser with a copy to the insurance company:</p> <ol style="list-style-type: none"> 1. 4 Copies of the Supplier invoice showing contract number, goods' description, quantity 2. unit price, total amount; 3. Insurance Certificate if applicable; 4. Manufacturer's/Supplier's warranty certificate; 5. Inspection Certificate issued by the nominated inspection agency, if any 6. Supplier's factory inspection report; and 7. Certificate of Origin (if possible by the beneficiary); 8. Two copies of the packing list identifying the contents of each package. 9. The above documents should be received by the Purchaser before arrival of the Goods (except where the Goods have been delivered directly to the Consignee with all documents) and, if not received, the Supplier will be responsible for any consequent expenses.
13.	<p>Delayed delivery: If the delivery is not made within the due date for any reason, the Committee will have the right to impose penalty 1% per week and the maximum deduction is 10% of the contract value / price.</p>
14.	<p>Prices: The price should be quoted in net per unit (after breakup) and must include all packing and delivery charges. The offer/bid should be exclusive of taxes and duties, which will be paid by the purchaser as applicable. However the percentage of taxes & duties shall be clearly indicated.</p>

	<p>The price should be quoted without custom duty and excise duty, since IIT Delhi is exempted from payment of Excise Duty and is eligible for concessional rate of custom duty. Necessary certificate will be issued on demand.</p> <p>In case of imports, the price should be quoted on FOB/FCA origin Airport Basis only. Under special circumstances (eg. perishable chemicals), when the item is imported on CIF/CIP, please indicate CIF/CIP charges separately upto IIT Delhi indicating the mode of shipment. IIT Delhi will make necessary arrangements for the clearance of imported goods at the Airport/Seaport. Hence the price should not include the above charges. At any circumstances, it is the responsibility of the foreign supplier to handover the material to our forwarder at the origin airport after completing all the inland clearing. Ex- Works consignment should be avoided.</p> <p>“In case of CIF/CIP shipments, kindly provide the shipment information at least 2 days in advance before landing the shipment along with the documents i.e. invoice, packing list, forwarder Name, address, contact No. in India to save penalty/demurrage charges (imposed by Indian Customs) . Otherwise these charges will be recovered from the supplier/Indian Agent.”</p> <p><i>Note: -Comparison of prices will be done ONLY on the bids submitted for the Main Equipment and anything asked as ‘Optional’ in the specs is not to be included for overall comparison.</i></p>
15.	<p>Notices: For the purpose of all notices, the following shall be the address of the Purchaser and Supplier.</p> <p>Purchaser: Prof. Bijay P. Tripathi Department of Materials Science & Engineering Indian Institute of Technology Hauz Khas, New Delhi – 110016, INDIA</p> <p>Supplier: (To be filled in by the supplier) (All supplier’s should submit its supplies information as per Annexure-II).</p> <p>_____</p> <p>_____</p>
16.	<p>Progress of Supply: Wherever applicable, supplier shall regularly intimate progress of supply, in writing, to the Purchaser as under:</p> <ol style="list-style-type: none"> 1. Quantity offered for inspection and date; 2. Quantity accepted/rejected by inspecting agency and date; 3. Quantity dispatched/delivered to consignees and date; 4. Quantity where incidental services have been satisfactorily completed with date; 5. Quantity where rectification/repair/replacement effected/completed on receipt of any communication from consignee/Purchaser with date; 6. Date of completion of entire Contract including incidental services, if any; and 7. Date of receipt of entire payments under the Contract (In case of stage-wise inspection, details required may also be specified).
17.	<p>Inspection and Tests: Inspection and tests prior to shipment of Goods and at final acceptance are as follows:</p> <ul style="list-style-type: none"> • After the goods are manufactured and assembled, inspection and testing of the goods shall be carried out at the supplier’s plant by the supplier, prior to shipment to check whether the goods are in conformity with the technical specifications attached to the purchase order. Manufacturer’s test certificate with data sheet shall be issued to this effect and submitted along with the delivery documents. The purchaser shall be present at the supplier’s premises during such inspection and testing if need is felt. The location where the inspection is required to be conducted should be clearly indicated. The supplier shall inform the purchaser about the site preparation, if any, needed for installation of the goods at the purchaser’s site at the time of submission of order acceptance. • The acceptance test will be conducted by the Purchaser, their consultant or other such person nominated by the Purchaser at its option after the equipment is installed at purchaser’s site in the

	<p>presence of supplier's representatives. The acceptance will involve trouble free operation and ascertaining conformity with the ordered specifications and quality. There shall not be any additional charges for carrying out acceptance test. No malfunction, partial or complete failure of any part of the equipment is expected to occur. The Supplier shall maintain necessary log in respect of the result of the test to establish to the entire satisfaction of the Purchaser, the successful completion of the test specified.</p> <ul style="list-style-type: none"> • In the event of the ordered item failing to pass the acceptance test, a period not exceeding one weeks will be given to rectify the defects and clear the acceptance test, failing which the Purchaser reserve the right to get the equipment replaced by the Supplier at no extra cost to the Purchaser. • Successful conduct and conclusion of the acceptance test for the installed goods and equipment shall also be the responsibility and at the cost of the Supplier.
18.	<p>Resolution of Disputes: The dispute resolution mechanism to be applied pursuant shall be as follows:</p> <ul style="list-style-type: none"> • In case of Dispute or difference arising between the Purchaser and a domestic supplier relating to any matter arising out of or connected with this agreement, such disputes or difference shall be settled in accordance with the Indian Arbitration & Conciliation Act, 1996, the rules there under and any statutory modifications or re-enactments thereof shall apply to the arbitration proceedings. The dispute shall be referred to the Director, Indian Institute of Technology (IIT) Delhi and if he is unable or unwilling to act, to the sole arbitration of some other person appointed by him willing to act as such Arbitrator. The award of the arbitrator so appointed shall be final, conclusive and binding on all parties to this order. • In the case of a dispute between the purchaser and a Foreign Supplier, the dispute shall be settled by arbitration in accordance with provision of sub-clause (a) above. But if this is not acceptable to the supplier then the dispute shall be settled in accordance with provisions of UNCITRAL (United Nations Commission on International Trade Law) Arbitration Rules. • The venue of the arbitration shall be the place from where the order is issued.
19.	<p>Applicable Law: The place of jurisdiction would be New Delhi (Delhi) INDIA.</p>
20.	<p>Right to Use Defective Goods If after delivery, acceptance and installation and within the guarantee and warranty period, the operation or use of the goods proves to be unsatisfactory, the Purchaser shall have the right to continue to operate or use such goods until rectifications of defects, errors or omissions by repair or by partial or complete replacement is made without interfering with the Purchaser's operation.</p>
21.	<p>Supplier Integrity The Supplier is responsible for and obliged to conduct all contracted activities in accordance with the Contract using state of the art methods and economic principles and exercising all means available to achieve the performance specified in the contract.</p>
22.	<p>Training The Supplier is required to provide training to the designated Purchaser's technical and end user personnel to enable them to effectively operate the total equipment.</p>
23.	<p>Installation & Demonstration The supplier is required to done the installation and demonstration of the equipment within one month of the arrival of materials at the IITD site of installation, otherwise the penalty clause will be the same as per the supply of materials.</p> <p>In case of any mishappening/damage to equipment and supplies during the carriage of supplies from the origin of equipment to the installation site, the supplier has to replace it with new equipment/supplies immediately at his own risk. Supplier will settle his claim with the insurance company as per his convenience. IITD will not be liable to any type of losses in any form.</p>
24.	<p>Insurance: For delivery of goods at the purchaser's premises, the insurance shall be obtained by the supplier in an amount equal to 110% of the value of the goods from "warehouse to warehouse" (final destinations) on "All Risks" basis including War Risks and Strikes. The insurance shall be valid for a</p>

	period of not less than 3 months after installation and commissioning. In case of orders placed on FOB/FCA basis, the purchaser shall arrange Insurance. If orders placed on CIF/CIP basis, the insurance should be up to IIT Delhi.
25.	<p>Incidental services: The incidental services also include:</p> <ul style="list-style-type: none"> ● Furnishing of 01 set of detailed operations & maintenance manual. ● Arranging the shifting/moving of the item to their location of final installation within IITD premises at the cost of Supplier through their Indian representatives.
26.	<p>Warranty:</p> <p>(i) Warranty period shall be (as stated at page #2 of this tender) from date of installation of Goods at the IITD site of installation. The Supplier shall, in addition, comply with the performance and/or consumption guarantees specified under the contract. If for reasons attributable to the Supplier, these guarantees are not attained in whole or in part, the Supplier shall at its discretion make such changes, modifications, and/or additions to the Goods or any part thereof as may be necessary in order to attain the contractual guarantees specified in the Contract at its own cost and expense and to carry out further performance tests. The warranty should be comprehensive on site.</p> <p>(ii) The Purchaser shall promptly notify the Supplier in writing of any claims arising under this warranty. Upon receipt of such notice, the Supplier shall immediately within in 02 days arrange to repair or replace the defective goods or parts thereof free of cost at the ultimate destination. The Supplier shall take over the replaced parts/goods at the time of their replacement. No claim whatsoever shall lie on the Purchaser for the replaced parts/goods thereafter. The period for correction of defects in the warranty period is 02 days. If the supplier having been notified fails to remedy the defects within 02 days, the purchaser may proceed to take such remedial action as may be necessary, at the supplier's risk and expenses and without prejudice to any other rights, which the purchaser may have against the supplier under the contract.</p> <p>(iii) The warranty period should be clearly mentioned. The maintenance charges (AMC) under different schemes after the expiry of the warranty should also be mentioned. The comprehensive warranty will commence from the date of the satisfactory installation/commissioning of the equipment against the defect of any manufacturing, workmanship and poor quality of the components.</p> <p>(iv) After the warranty period is over, Annual Maintenance Contract (AMC)/Comprehensive Maintenance Contract (CMC) up to next two years should be started. The AMC/CMC charges will not be included in computing the total cost of the equipment.</p>
27.	<p>Governing Language</p> <p>The contract shall be written in English language. English language version of the Contract shall govern its interpretation. All correspondence and other documents pertaining to the Contract, which are exchanged by the parties, shall be written in the same language.</p>
28.	<p>Applicable Law</p> <p>The Contract shall be interpreted in accordance with the laws of the Union of India and all disputes shall be subject to place of jurisdiction.</p>
29.	<p>Notices</p> <ul style="list-style-type: none"> ● Any notice given by one party to the other pursuant to this contract/order shall be sent to the other party in writing or by cable, telex, FAX or e mail and confirmed in writing to the other party's address. ● A notice shall be effective when delivered or on the notice's effective date, whichever is later.
30.	<p>Taxes</p> <p>Suppliers shall be entirely responsible for all taxes, duties, license fees, octroi, road permits, etc., incurred until delivery of the contracted Goods to the Purchaser. However, GST etc, in respect of the transaction between the Purchaser and the Supplier shall be payable extra, if so stipulated in the order.</p>

	For research purpose(s) ONLY , 5% GST will be applicable with concessional GST Certificate.
31.	<p>Duties IIT Delhi is exempted from paying custom duty under notification No.51/96 (partially or full) and necessary “Custom Duty Exemption Certificate” can be issued after providing following information and Custom Duty Exemption Certificate will be issued to the shipment in the name of the Institute, (no certificate will be issued to third party): The procured product should be used for teaching, scientific and research work only.</p> <p>a) Shipping details i.e. Master Airway Bill No. and House Airway No. (if exists) b) Forwarder details i.e. Name, Contact No., etc.</p> <p>IIT Delhi is partially exempted from paying GST and necessary GST Exemption Certificate will be provided for which following information are required.</p> <p>b) Quotation with details of Basic Price, Rate, Tax & Amount on which ED is applicable c) Supply Order Copy d) Proforma-Invoice Copy.</p>
32.	<p>Agency Commission: Agency commission if any will be paid to the Indian agent in Rupees on receipt of the equipment and after satisfactory installation. Agency Commission will not be paid in foreign currency under any circumstances. The details should be explicitly shown in Tender even in case of Nil commission. The tenderer should indicate the percentage of agency commission to be paid to the Indian agent.</p>
33.	<p>Payment:</p> <p>(i) For imported items Payment will be made through irrevocable Letter of Credit (LC) Cash Against Documents (CAD)/Against delivery/after satisfactory installation by T.T. Letter of Credit (LC) will be established in favour of foreign Supplier after the submission of performance security. The letter of credit (LC) will be established on the exchange rates as applicable on the date of establishment. For Imports, LC will be opened for 100% FOB/CIF value. 80% of the LC amount shall be released on presentation of complete and clear shipping documents and 20% of the LC amount shall be released after the installation and demonstration of the equipment at the INST site of installation in faultless working condition for period of 60 days from the date of the satisfactory installation and subject to the production of unconditional performance bank guarantee as specified in Clause 8 of tender terms and conditions.</p> <p>(ii) For Indigenous supplies, 100% payment shall be made by the Purchaser against delivery, inspection, successful installation, commissioning and acceptance of the equipment at IITD in good condition and to the entire satisfaction of the Purchaser and on production of unconditional performance bank guarantee as specified in Clause 9 of tender terms and conditions.</p> <p>(iii) Indian Agency commission (IAC), if any shall be paid after satisfactory installation & commissioning of the goods at the destination at the exchange rate prevailing on the date of negotiation of LC documents, subject to DGS&D registration for restricted items.</p> <p>(iv) All the bank charges within India will be borne by the Institute and outside India will be borne by the Supplier.</p>
34.	<p>User list: Brochure detailing technical specifications and performance, list of industrial and educational establishments where the items enquired have been supplied must be provided. (Ref. Annexure-III)</p>
35.	<p>Manuals and Drawings</p> <p>(i) Before the goods and equipment are taken over by the Purchaser, the Supplier shall supply operation and maintenance manuals. These shall be in such details as will enable the Purchaser to operate, maintain, adjust and repair all parts of the works as stated in the specifications.</p> <p>(ii) The Manuals shall be in the ruling language (English) in such form and numbers as stated in the contract.</p>

	(iii) Unless and otherwise agreed, the goods equipment shall not be considered to be completed for the purposes of taking over until such manuals and drawing have been supplied to the Purchaser.
36.	Application Specialist: The Tenderer should mention in the Techno-Commercial bid the availability and names of Application Specialist and Service Engineers in the nearest regional office. (Ref. to Annexure-III)
37.	Site Preparation: The supplier shall inform to the Institute about the site preparation, if any, needed for the installation of equipment, immediately after the receipt of the purchase order. The supplier must provide complete details regarding space and all the other infrastructural requirements needed for the equipment, which the Institute should arrange before the arrival of the equipment to ensure its timely installation and smooth operation thereafter. The supplier shall visit the Institute and see the site where the equipment is to be installed and may offer his advice and render assistance to the Institute in the preparation of the site and other pre-installation requirements.
38.	Spare Parts The Supplier may be required to provide any or all of the following materials, notifications, and information pertaining to spare parts manufactured or distributed by the Supplier: ii. Such spare parts as the Purchaser may elect to purchase from the Supplier, providing that this election shall not relieve the Supplier of any warranty obligations under the Contract; and iii. In the event of termination of production of the spare parts: iv. Advance notification to the Purchaser of the pending termination, in sufficient time to permit the Purchaser to procure needed requirements; and v. Following such termination, furnishing at no cost to the Purchaser, the blueprints, drawings and specifications of the spare parts, if requested. Supplier shall carry sufficient inventories to assure ex-stock supply of consumable spares for the Goods, such as gaskets, plugs, washers, belts etc. Other spare parts and components shall be supplied as promptly as possible but in any case within six months of placement of order.
39.	Defective Equipment: If any of the equipment supplied by the Tenderer is found to be substandard, refurbished, un-merchantable or not in accordance with the description/specification or otherwise faulty, the committee will have the right to reject the equipment or its part. The prices of such equipment shall be refunded by the Tenderer with 18% interest if such payments for such equipment have already been made. All damaged or unapproved goods shall be returned at suppliers cost and risk and the incidental expenses incurred thereon shall be recovered from the supplier. Defective part in equipment, if found before installation and/or during warranty period, shall be replaced within 45 days on receipt of the intimation from this office at the cost and risk of supplier including all other charges. In case supplier fails to replace above item as per above terms & conditions, IIT Delhi may consider "Banning" the supplier.
40.	Termination for Default The Purchaser may, without prejudice to any other remedy for breach of contract, by written notice of default sent to the Supplier, terminate the Contract in whole or part: i. If the Supplier fails to deliver any or all of the Goods within the period(s) specified in the order, or within any extension thereof granted by the Purchaser; or ii If the Supplier fails to perform any other obligation(s) under the Contract. iii If the Supplier, in the judgment of the Purchaser has engaged in corrupt or fraudulent practices in competing for or in executing the Contract. ● For the purpose of this Clause: i. “ Corrupt practice ” means the offering, giving, receiving or soliciting of anything of value to influence the action of a public official in the procurement process or in contract execution. ii. “ Fraudulent practice ” means a misrepresentation of facts in order to influence a procurement process or the execution of a contract to the detriment of the Borrower, and includes

	<p>collusive practice among Bidders (prior to or after bid submission) designed to establish bid prices at artificial non-competitive levels and to deprive the Borrower of the benefits of free and open competition;”</p> <ul style="list-style-type: none"> ● In the event the Purchaser terminates the Contract in whole or in part, the Purchaser may procure, upon such terms and in such manner, as it deems appropriate, Goods or Services similar to those undelivered, and the Supplier shall be liable to the Purchaser for any excess costs for such similar Goods or Services. However, the Supplier shall continue the performance of the Contract to the extent not terminated.
41.	Shifting: After 1-2 years once our new Academic Block will be ready, the supplier has to shift and reinstall the instrument free of cost (if required).
42.	Downtime: During the warranty period not more than 5% downtime will be permissible. For every day exceeding permissible downtime, penalty of 1/365 of the 5% FOB value will be imposed. Downtime will be counted from the date and time of the filing of complaint with in the business hours.
43.	Training of Personnel: The supplier shall be required to undertake to provide the technical training to the personnel involved in the use of the equipment at the Institute premises, immediately after completing the installation of the equipment for a minimum period of one week at the supplier’s cost.
44.	Disputes and Jurisdiction: Any legal disputes arising out of any breach of contract pertaining to this tender shall be settled in the court of competent jurisdiction located within New Delhi.
45.	Compliance certificate: This certificate must be provided indicating conformity to the technical specifications. (Annexure-I)

COMPLIANCE SHEET

TECHNICAL SPECIFICATION

S. N.	Technical specification	Compliance Yes/No
	<p>General Specifications:</p> <p>Integrated Multimode Atomic Force Microscope with Nanoscale Infrared Spectroscopy Microscope with tunable IR laser as the source for covering broad IR Range. Multimode AFM with varieties of modules offers mechanical, electronic, and thermal characterization at the surface and at the nanoscale. Along with tunable IR laser sources, it will allow mapping both topography and IR absorption (chemical signature(s)) at the nanometer scale. The system should provide high spatial resolution, excellent sensitivity, and correlation to bulk FTIR spectra. The system should be based on a Non-Destructive Technique in IR Imaging. The system must be capable of measuring the AFM-IR data of both Organic and Inorganic materials, which includes 1D/2D Materials, CNTs, Polymers, Polymers Blends, Block Copolymer, Oxide, and non-oxide Thin Films, Glass, Semiconductors, Fibers, Hydrocarbons, Cells, Biomaterials, Nanophotonics, Nanoplasmonics, Organic/Inorganic Composites, OLED Materials, Zeolite, Soft samples, Monolayer, etc. Further, the system should be capable of characterizing various mechanical (such as tribological, viscoelastic, etc. properties;), electronic (electrostatic, magnetic, Kelvin probe, conductive, etc. properties), and thermal properties (temperature-dependent mechanical and electrical property, thermal conductivity, etc.) Peer-reviewed scientific publications should be provided for proof of all the capabilities claimed in the tender. Detailed specifications are described below:</p>	
2.	AFM Specifications	
4.3.	Scanner head:	
4.3.1.	AFM Head/Scanner Material should be made from material for best thermal stability. Invar would be preferred.	
4.3.2.	AFM Deflection Laser wavelength should be higher or equal to 600 nm or equivalent.	
4.3.3.	System z-noise floor <100 pm rms	
4.3.4.	Detector Bandwidth: up to 6 MHz	
4.3.5.	Operational modes: Ambient and liquid cell	
4.3.6.	Should support all standard modes of operation with the possibility for upgradation with specific modes or the features given in the optional list.	
4.3.7.	Provide Tapping mode and contact mode based on photothermal technique/photo-induced force microscopy for IR spectra and chemical imaging covering the full requested Laser	

	range. Vendors must also provide AFM IR mode operating at resonance for characterizing monolayers and thin films.	
4.3.8.	AFM head incorporates a parabolic mirror controlled by 3D piezo motor/scanner, allowing the laser to excite the sample and tip from the top side. The range of parabolic mirror is 1 mm × 1 mm × 0.8 mm (stepping mode), and 15 μm × 15 μm × 15 μm (scanning mode) with 10 nm resolution, the NA of the parabolic mirror is ~0.5. Any other equivalent technology providing equivalent or better results is also acceptable.	
4.3.9.	Either inverted or top view illumination is preferred.	
4.3.10.	Sample size: 25 mm x 25 mm x 10 mm or more.	
4.4.	Scanner	
4.4.1.	XY& Z range - 80 micron × 80 micron × 10 micron or better.	
4.4.2.	Dual Z feedback – The AFM feedback mechanism must drive both the sample Z with ≥ 10 μm range and fast tip Z piezo with ≤ 1 μm with 20kHz bandwidth. Piezo elements to produce the best AFM feedback while maintaining the tight focus of the excitation laser on the tip apex region. Any other equivalent technology providing similar or better results is also acceptable.	
4.4.3.	Scanner operation Closed loop with capacitive sensors in XY & Z	
4.4.4.	XY Scanning Sensor Noise: <200 pm or lower	
4.4.5.	Z scanner sensor noise: <100 pm or better for the full range	
4.4.6.	The system should have a flexure design	
4.5.	Positioning System	
4.5.1.	Motorized Coarse positioning range of tip in Z > 10 mm	
4.5.2.	XY positioning type of sample at a minimum of 25 mm x 25 mm motorized with absolute position sensor	
4.5.3.	The system shall include an integrated optical microscope coupled to a 5MP digital camera and computer display. The optical imaging shall be in top view (i.e., looking down on the cantilever), with a minimum spatial resolution of 2 μm. Any other equivalent technology providing similar or better results is also acceptable.	
4.5.4.	XY sample positioning repeatability < 1 μm	
4.5.5.	Sensor resolution for position sensor < 100 nm rms	
4.6.	AFM modes	
4.6.1.	The system should be capable of providing high resolution imaging at typical imaging speeds (~2min/scan with 256x256 pixels) in air and the liquid environment by imaging at the off-resonance frequency by driving the z scanner in sinusoid fashion. The oscillation should be user controlled and vary up to 2kHz or greater.	

4.6.2.	Contact mode	
4.6.3.	Tapping mode (air/liquid).	
4.6.4.	Thermal tuning	
4.6.5.	Liquid Imaging for AFM only	
4.6.6.	Lateral Force Microscopy	
4.6.7.	Force spectroscopy	
4.6.8.	Phase Imaging	
4.6.9.	Magnetic Force Microscopy (MFM)	
4.6.10.	Kelvin Probe Force Microscopy (KPFM) for surface potential	
4.6.11.	Piezoresponse force microscopy (PFM) with +/- 10V or higher	
4.6.12.	Electrostatic force microscopy (EFM).	
4.6.13.	Nanoscale mechanical mode or equivalent mode providing:	
4.6.13.1	AFM-based Dynamic Mechanical Analysis with sample modulation from 0.1Hz to 300Hz or equivalent or better	
4.6.13.2	Provide results of storage modulus (E'), loss modulus (E''), and tan delta for a complete rheological analysis at sub-100 nm spatial resolution with excellent correlation to bulk DMA and nanoindentation methods.	
4.6.13.3	Provide spectroscopy capabilities for single points, point-arrays, or mapping at a rheological frequency range of 0.1Hz to 300Hz or broader with variable temperature from room temperature (RT) to 250-degrees Celsius or equivalent or better	
4.6.13.4	Able to characterize rheological behavior of viscoelastic materials to generate master curves through a comprehensive process to generate time-temperature superposition data and calculate activation energy using the Arrhenius model.	
4.6.13.5	Should have a high stability sample heater, RT to 250-degrees Celsius in the air or other inert gases to measure samples at various temperatures required for calculating time-temperature superposition material master curves.	
4.6.13.6	Should have a temperature controller and a chiller for high efficiency heating and fast temperature ramping controlled through software	
4.6.13.7	Provide reference sample kits consisting of the following samples/substrates: one (1) Fluorinated Ethylene Propylene, one (1) Polycarbonate-ABS, and ten (10) 10mm Sapphire windows	
4.6.13.8	Includes 10 Calibrated Probes each of different Models applicable for quoted system	
4.6.13.9	Includes a heater cantilever holder and standard cantilever holder	
4.7.	Conductive AFM:	

4.7.1.	Measure conductive properties in both contact and tapping mode at typical imaging speed (<2 min/scan of 256x256 pixels).	
4.7.2.	Achieves >10kHz bandwidth for peak current detection and provides sub-100fA noise level	
4.7.3.	10 probes with the complete package.	
4.8.	Sample Heating Cooling Stage:	
4.8.1.	Room Temperature to 250 Deg C or more	
4.8.2.	-20 Deg C to 80 Deg C or better.	
4.9.	AFM probes:	
4.9.1.	200 number of tips for use in AFM-IR.	
4.9.2.	Two Contact/tapping (air) cantilever holders,	
4.9.3.	20 numbers of probes and required accessories for each specific AFM mode should be provided.	
4.10.	Optical access top view for position observation	
4.10.1.	Top optics (for position observation) 10X, 0.2 NA Lens or equivalent or better	
4.10.2.	Tip-Sample Approach: Automated engagement via 3 stepper motors or equivalent	
4.10.3.	Illumination: Software controlled LED	
4.10.4.	CCD camera: > 5MP, with pixel image resolution of 500 nm or better and optical spatial resolution < 1.5 μm) or better or equivalent.	
5.	Tunable Infrared Laser Source and Imaging	
5.1.	QCL IR Source	
5.1.1.	Tuning range - $\sim 770\text{ cm}^{-1}$ to 1860 cm^{-1} or more	
5.1.2.	Spectral linewidth < 2 cm^{-1} or better	
5.1.3.	Spectral Accuracy < 2 cm^{-1} or or equivalent or better	
5.1.4.	Repeatability: < 0.5 cm^{-1} or or equivalent or better	
5.1.5.	Average Power: 1 - 15 mW over the entire tuning range	
5.1.6.	Power Stability: <5% pulse-to-pulse (typical)	
5.1.7.	Pulse Repetition Frequency: up to 3 MHz;	
5.1.8.	Pointing Stability: <2 mrad in full tuning range and 40 msec tuning speed in full range to support fast spectrum acquisition with 0.1 s per spectrum and hyperspectral IR imaging with a spectrum over full range in every pixel	
5.1.9.	Cooling: Water cooling for silent operation. Appropriate chillers should be included in the quotation.	
5.1.10.	Required multiplexer/tuners should be included to cover the complete range of the source as mentioned above.	

5.1.11.	Beam steering: 3D piezo motor/scanner/Motorized tip/tilt	
5.1.12.	With the Pulsed QCL laser source, it should be possible to operate in hyperspectral imaging and spectroscopy in the complete tunable range	
5.1.13.	Speeds of 0.2 seconds per pixel should be possible per spectrum	
5.2.	OPO Laser	
5.2.1.	OPO Single Housing Picosecond Laser	
5.2.2.	85 MHz \pm 5 MHz PRR;	
5.2.3.	70 \pm 10 ps pulse duration;	
5.2.4.	Tuning ranges; 2250 cm ⁻¹ –3600 cm ⁻¹ or broader	
5.2.5.	Spectral resolution: <4 cm ⁻¹ or equivalent or better	
5.2.6.	Beam diameter 2-3 mm	
5.2.7.	Acoustic-optic modulator to allow heterodyne AFM measurements with non-contact AFM cantilevers. Any other equivalent technology is acceptable.	
5.2.8.	Material: single crystal optical germanium or equivalent	
5.2.9.	Water cooling: 250 ml/min approximately 23 °C or equivalent or better. appropriate chillers to be provided	
5.2.10.	Size (less connector): 38.1 h x 76.2 d x 33.0 w cm;	
5.2.11.	Modulator driver	
5.2.12.	Motorized laser multiplexer to accommodate OPO and QCL lasers with additional available ports.	
5.2.13.	Automatic switching between OPO and QCL sources should be possible (if applicable).	
5.3.	Nanoscale IR Imaging	
	The system must be able to generate both fixed wavenumber images and spectrum with the same laser/s. The spectrum on PES (polyethersulfone) must be generated and shown good agreement with a published FTIR spectrum.	
6.	Controller, Software, PC, Active Vibration	
6.1.1.	High-Speed Electronics & Controller Module	
6.1.1.1.	FPGA-based control electronics have a section dedicated to high-speed scanning probe microscopy.	
6.1.1.2.	Sampling Rate: >500 MHz for channels A & B; Channel A dedicated for photodiode detection for high-speed AFM	
6.1.1.3.	Lock-in Amplifiers (LIA): 3 or more independent 2-phase lock-in amplifiers (LIA0 to LIA3). LIA Operation Frequency: Up to 10 MHz. LIA Synchronization: fully synchronized from one clock source.	
6.1.1.4.	High-Speed Sine Wave Generator: Two channels with 160 kHz sampling rates; one reserved for scan generator for high-speed AFM	

6.1.1.5.	Maximum Feedback Throughput: 1 Mps with Dual-Z feedback	
6.1.1.6.	Integrated Synchronized Laser Driver.	
6.1.1.7.	Standard DAC Channels: 10 or more channels: 20-bit or higher, >150 kHz data rate	
6.1.1.8.	Standard ADC Channels: 8 or more channels: 20-bit or higher, >150 kHz data rate	
6.1.1.9.	TTL Signal Generator: Two flexible TTL signal generators (with 160 kHz sampling rate) with adjustable duty cycle and DC offset for direct current modulation of laser diodes or for input to Bragg cells. Or equivalent.	
6.1.1.10	Flexible Lock-in Referencing: The LIAs can be phase locked to any other LIA or at any calculated frequencies from the other LIAs	
6.1.2.	Image Acquisition Software:	
6.1.2.1.	Should have the capability to locate and zoom in/out of pre-acquired images on the same sample.	
6.1.2.2.	The system must provide simultaneous measurement of IR absorption, sample topography, and contact resonance based mechanics from the amplitude and frequency of the cantilever oscillation. Publications should be provided for proof of capability.	
6.1.2.3.	AFM IR absorption detection mechanism must be fully disclosed and must not be in conflict with any registered patents. References to be provided.	
6.1.2.4.	Straightforward interpretation of detection of infrared absorption, e.g., without need to interpret or model complex scattering near-field optical signal. Provide proof through peer reviewed publications that such spectral interpretations are indeed possible for solid samples.	
6.1.2.5.	The technique should directly correlate to FTIR libraries for polymeric materials with proven examples.	
6.1.2.6.	Provide both high resolution spectroscopy and fixed wavelength chemical imaging with the same mid-IR laser source.	
6.1.2.7.	Automated background compensation for IR spectroscopy	
6.1.2.8.	Demonstrate <10 nm chemical imaging spatial resolution. Provide proof with measurement data	
6.1.2.9.	Tapping mode based photothermal technique must be insensitive to non-local background forces providing material selectivity via resonance tuning technique	
6.1.2.10	HOTspot tracking and optimization of IR laser onto the probe tip to minimize measurement set-up times	
6.1.2.11	QCL based laser provides both spectroscopy and chemical imaging for Tapping AFM-IR and Resonance enhanced (Contact) AFM-IR across the fully accessible spectral range.	

6.1.2.12	The system must allow the user to perform IR imaging at any fixed wavenumber within the tuning range of the IR source and allow for image ratio and subtraction analysis	
6.1.2.13	Provide the capability for hyperspectral imaging with the photothermal or equivalent AFM-IR technique providing spectra at each pixel with <1sec and a spectral array map of up to 128 x 128 pixels.	
6.1.3.	Environmental	
6.1.3.1.	Suitable vibration isolation and environmental control must be included to ensure the performance and operation of all mentioned AFM and AFM-IR modes.	
6.1.3.2.	Suitable Active Vibration Isolation system with active bandwidth 0.6 to 200 Hz	
6.1.3.3.	Acoustic Enclosure with the capability to keep the temperature controlled to +/- 0.2C. Front door with gas lift and opens upwards.	
6.1.3.4.	Dry Air generator/filtration set up to provide quiet, clean, and water-absorption-free operation. Any other equivalent technology will be acceptable.	
6.1.3.5.	Provide an option for AFM-IR in environmental control with humidity control. The humidity control should be from 10% to 80% or better, non-condensing.	
6.1.4.	Computer:	
6.1.4.1.	Suitable table and rack for computer/CPU.	
6.1.4.2.	Minimum configuration includes 3.4GHz Quad Core (Intel i7 or equivalent processor), 16 GB RAM, 256GB SSD, and 2000GB HD combination, 8X USB ports, Windows 10-64 bit Professional or better configuration.	
6.1.4.3.	Two flat-panel computer monitors (minimum size 30") for simultaneous display of multiple control menus, analysis, and images.	
6.1.5.	Suitable UPS should be provided with at least 1 hr backup.	
7.	Other terms and conditions:	
7.1.	Support and Service	
7.1.1.	The Supplier shall provide a comprehensive warranty for a minimum of three (3) years from the date of installation. Warranty must include unlimited telephone/e-mail support during the warranty period for questions regarding operation.	
7.1.2.	If a less than 3-year warranty is offered for any particular component, then suitable justification should be provided with an optional quote for an additional warranty period. The committee will have the right to accept it or not.	
7.1.3.	This warranty must cover non-consumable parts replacement and travel/labor on-site should this become necessary within the warranty period.	
7.1.4.	For the warranty period, only factory-trained and certified engineers are acceptable to attend the service.	

7.1.5.	The response time with an engineer on site must be less than 48 hours from the failure notification. The company must provide evidence that it can fulfill this requirement.	
7.1.6.	If the parts are required to be imported for repairs, the same should be made available within 4 weeks from the date of reporting the issue. Any extension in this time will need to be compensated by the manufacturer by extending the comprehensive warranty by the excess period taken (i.e., the period beyond 4 weeks) in completing the repairs.	
7.1.7.	The supplier must provide sophisticated web-based instrument diagnostics to provide the customer with rapid support for applications assistance and instrument troubleshooting.	
7.1.8.	The supplier should arrange 6 training sessions (spread over the first two years).	
7.1.9.	Full-time free upgrade of the software associated with the equipment.	
7.1.10.	Any data analysis software required for the system should be made available for at least 10 computers.	
7.1.11.	Details of the installation and user response should be provided from at least 3 reputed international/ national labs and universities.	
7.1.12.	All prices quoted for CIP New Delhi	
7.2.	Acceptance Criteria	
7.2.1.	Checking together with the customer that the instrument is delivered in full and in agreement with the PO.	
7.2.2.	XYZ Calibration: Performed the Z calibration using the XYZ calibration sample and confirm the calibration with the Z center voltage centered is within the specification.	
7.2.3.	Z noise: Engage on freshly cleaved HOPG in tapping with new 125um probe. Change Setpoint to 10V to retract piezo. Do cantilever tune and check f is just to the left of the peak. Adjust drive strength, so the amplitude is 9V. Now change Setpoint to 7.5 V. Scan at 0.003 x 0.001 um, 1 Hz, 512 x 64, ig=2.5 pg=5.0. Capture height image. Do 1 st order flatten, measure RMS of the entire image. It should be below 100 pm, with no periodic noises.	
7.2.4.	All the lasers must be capable of AFM-IR by cantilever detection for both fixed wavenumber imaging and single and multipoint full range spectra. The spatial resolution of AFM IR should be at least 10 nm. The 10 nm spatial resolution must be demonstrated during the site acceptance test by imaging a PS-PMMA block copolymer with a half pitch of 21 nm or smaller; the PS block should be acquired at ~ 1492 cm ⁻¹ and ~ 2956 cm ⁻¹ and PMMA at ~ 1733 cm ⁻¹ and ~ 2853 cm ⁻¹ along with AFM topography and phase.	

Sl. No.	List of optional items	
	Two-year APMC after the end of comprehensive warranty	

I have also enclosed all relevant documents in support of my claims, (as above) in the following pages.

Signature of Bidder

Name: _____

Designation: _____

Organization Name: _____

Contact No. : _____

**<< Organization Letter Head >>
DECLARATION SHEET**

We, _____ hereby certify that all the information and data furnished by our organization with regard to this tender specification are true and complete to the best of our knowledge. I have gone through the specification, conditions and stipulations in details and agree to comply with the requirements and intent of specification.

This is certified that our organization has been authorized (Copy attached) by the OEM to participate in Tender. We further certified that our organization meets all the conditions of eligibility criteria laid down in this tender document. Moreover, OEM has agreed to support on regular basis with technology / product updates and extend support for the warranty.

The prices quoted in the financial bids are subsidized due to academic discount given to IIT Delhi.

We, further specifically certify that our organization has not been Black Listed/De Listed or put to any Holiday by any Institutional Agency/ Govt. Department/ Public Sector Undertaking in the last three years.	NAME & ADDRESS OF THE Vendor/ Manufacturer / Agent
1 Phone	
2 Fax	
3 E-mail	
4 Contact Person Name	
5 Mobile Number	
6 GST Number	
7 PAN Number	
(In case of on-line payment of Tender Fees)	
8 UTR No. (For Tender Fee)	
(In case of on-line payment of EMD)	
9 UTR No. (For EMD)	
10 Kindly provide bank details of the bidder in the following format: a) Name of the Bank	
b) Account Number	
c) Kindly attach scanned copy of one Cheque book page to enable us to return the EMD to unsuccessful bidder	

(Signature of the Tenderer)

Name:

Seal of the Company

List of Govt. Organization/Deptt.

List of Government Organizations for whom the Bidder has undertaken such work during last three years (must be supported with work orders)		
Name of the organization	Name of Contact Person	Contact No.

Name of application specialist / Service Engineer who have the technical competency to handle and support the quoted product during the warranty period.		
Name of the organization	Name of Contact Person	Contact No.

Signature of Bidder

Name: _____

Designation: _____

Organization Name: _____

Contact No. : _____

PREVIOUS SUPPLY ORDER DETAILS

(ANNEXURE – IV)

Name of the Firm _____

Order placed by (Full address of Purchaser)	Order No. and Date	Description and quantity of order equipment	Value of order	Date of Completion of delivery as per contract	Has the equipment been installed satisfactorily (Attach a Certificate from the Purchaser/ Consignee)	Contact person along with Telephone No., Fax No. and email address)

Signature and Seal of the Manufacturer/ Bidder

Place: _____

Date: _____

ORIGINAL EQUIPMENT MANUFACTURER (OEM)
Manufacturing authorisation form (MAF)
(On Letter Head of Manufacturer)

Tender No. :-

Date:-

To
The Director,
Indian Institute of Technology Delhi,
New Delhi- 110016

Dear Sir,

We manufactures of original equipment at (.....address of factory.....) do hereby authorize M/s (Name and address of Agent) to submit a bid, negotiate and receive the order format against your tender enquiry.

M/s. is authorized to bid and conclude the contract in regard to this business.

We hereby extend our full guarantee and warranty as per clause of the terms and conditions NIQ for the goods and services offered by the above firm.

Yours Faithfully,

(Name)

(Name & Seal of Manufactures)

Note: -

1. **Items of indigenous nature or quoted in INR**, more than 1 authorized representative may participate in the same tender and submit their bids on behalf of their OEM/Principal/Manufacturer if the OEM permits more than one authorized bidder in such case as per their policy.
2. **In cases of agents quoting in offshore procurements**, on behalf of their principal manufacturers, one agent cannot represent two manufacturers or quote on their behalf in a particular tender enquiry. **One manufacturer can also authorize only one agent/dealer**
3. The letter of authority should be on the letterhead of the manufacturer and should be signed by a person competent and having the power of attorney to bind the manufacturer. The same should be included by the bidder in its techno-commercial unpriced bid.

<On Organization Letter Head>

(ANNEXURE-VI)

(For Goods/ Services Contracts)

No. _____

Dated: _____

CERTIFICATE

I have read the clause regarding restrictions on procurement from a bidder of a country which shares a land border with India and hereby certify that this bidder is not from such a country.

OR (whichever is applicable)

I have read the clause regarding restrictions on procurement from a bidder of a country which shares a land border with India and hereby certify that this bidder is from _____ (*Name of Country*) and has been registered with the Competent Authority. I also certify that this bidder fulfills all the requirements in this regard and is eligible to be considered.

(Copy/ evidence of valid registration by the Competent Authority is to be attached)

Signature of Bidder/ Agent

Name: _____

Designation: _____

Organization Name: _____

Contact No. : _____

<On Organization Letter Head>

(ANNEXURE-VII)

(For Works Contracts, including Turnkey contracts)

No. _____

Dated: _____

CERTIFICATE

I have read the clause regarding restrictions on procurement from a bidder of a country which shares a land border with India and on sub-contracting to contractors from such countries and hereby certify that this bidder is not from such a country and will not sub-contract any work to a contractor from such countries unless such contractor is registered with the Competent Authority.

OR (whichever is applicable)

I have read the clause regarding restrictions on procurement from a bidder of a country which shares a land border with India and on sub-contracting to contractors from such countries and hereby certify that this bidder is from _____ (*Name of Country*) and has been registered with the Competent Authority and will not sub-contract any work to a contractor from such countries unless such contractor is registered with the Competent Authority. I also certify that this bidder fulfills all the requirements in this regard and is eligible to be considered.

(Copy/ evidence of valid registration by the Competent Authority is to be attached)

Signature of Bidder/ Agent

Name: _____

Designation: _____

Organization Name: _____

Contact No. : _____

BID SECURITY UNDERTAKING

(To be issued by the bidder on company's letterhead in lieu of EMD)

To,

The Registrar,
I.I.T. Delhi, Hauz Khas,
Delhi – 110016.

We, M/s _____ (Name of the Firm), with ref. to Tender

No. _____ dated _____ hereby undertake that:

1. We accept all terms and conditions of the tender document.
2. We accept that, we will not modify our bid during the bid validity period and will honour the contract after the award of contract.
3. In the event of any modification to our bid by us or failure on our part to honour the contract after final award, our firm may be debarred from participation in any tender/ contract notified by IIT Delhi for a period of one year.

Yours faithfully,

(signature)

Name:

Date:

Office Seal:

BID SUBMISSION

Online Bid Submission:

The Online bids (complete in all respect) must be uploaded online in **two** Envelopes as explained below: -

Envelope – 1 (Following documents to be provided as single PDF file)			
Sl. No.	Document	Content	File Types
1.	Technical Bid	Compliance Sheet (Annexure - I)	.PDF
2.		Organization Declaration (Annexure - II)	.PDF
3.		List of organizations/ clients where the same products have been supplied (in last two years) along with their contact number(s). (Annexure-III)	.PDF
4.		Technical supporting documents in support of all claims made at Annexure-I	.PDF
5.		Previous Supply Order (Annexure - IV)	.PDF
6.		Original Equipment Manufacturing Manufacturing Authorization Form (MAF) (Annexure - V)	.PDF
7.		<i>(For Goods/ Services Contracts)</i> Certificate - Bidder Not from/ from Country sharing Land border with India & Registration of Bidder with Competent Authority (Annexure-VI)	.PDF
8.		<i>(For Works Contracts, including Turnkey Contracts)</i> Certificate – Bidder Not from/ from Country sharing Land border with India, Registration of Bidder with Competent Authority & not sub-contract any work to a contractor from such countries unless such contractor is registered with the Competent Authority (Annexure-VII)	.PDF
9.		Bid Security Undertaking in lieu of EMD (Annexure-VIII)	.PDF
Envelope – 2			
Sl. No.	Document	Content	File Types
1.	Financial Bid	Price bid should be submitted in given BOQ_XXXX.xls format. <i>(Note: -Comparison of prices will be done ONLY on the bids submitted for the Main Equipment and anything asked as ‘Optional’ in the specs is not to be included for overall comparison.)</i> Bids for optional items are to be submitted in ‘sheet2_Quote for optional items’	.XLS